

Preliminary Datasheet Version
1.0



Table 1 key parameters

Parameters	Values	Units
$V_{DS, max}$	700	V
V_{gth}	2.6	V
$R_{DS(on), Typ}$	180	mΩ
Q_G	2	nC
$I_D, Pulse$	18	A
$Q_{OSS} @ 400 V$	17	nC
Q_{rr}	0	nC

Description

This is a 700V GaN-on-Si enhancement-mode power transistor. The properties of GaN allow for high current, high breakdown voltage and high switching frequency.



Features

- Ultra-low FOM
- Ultra-high switching frequency
- Reverse current capability
- Zero reverse recovery loss
- Monolithic integrated ESD protection
- N-MOS pin-to-pin compatible
- RoHS, Pb-free, REACH-compliant

Applications

- AC/DC converters
- DC/DC converters
- Bridgeless totem pole PFC
- Fast chargers
- Power adapters
- LED lighting drivers
- Wireless power transfer
- Laser drivers
- TV display

Table2 Ordering Information

Ordering Code	Package	Product code
GP70R180T2P	TO202F Fullpackage	GP70R180T2P

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1 Maximum ratings

at $T_j = 25\text{ °C}$ unless otherwise specified. Continuous application of maximum ratings can deteriorate transistor lifetime.

Table 3 Maximum rating

Parameters	Symbols	Values	Units	Notes/Test Conditions
Drain-source voltage	$V_{DS, \max}$	700	V	$V_{GS} = 0\text{ V}$ $T_j = -55\text{ °C}$ to 150 °C
Drain-source voltage transient ¹	$V_{DS, \text{transient}}$	700	V	$V_{GS} = 0\text{ V}$
Continuous current, drain-source	I_D	10	A	$T_c = 25\text{ °C}$
Pulsed current, drain-source ²	$I_{D, \text{pulse}}$	18	A	$T_c = 25\text{ °C}$; $V_G = 6\text{ V}$
Pulsed current, drain-source ²	$I_{D, \text{pulse}}$	10	A	$T_c = 125\text{ °C}$; $V_G = 6\text{ V}$
Gate-source voltage, continuous	V_{GS}	-1 to +12	V	$T_j = -55\text{ °C}$ to 150 °C
Gate-source voltage, pulsed	$V_{GS, \text{pulse}}$	-10 to +20	V	$T_j = -55\text{ °C}$ to 150 °C ; $t_{\text{Pulse}} = 50\text{ ns}$, $f = 100\text{ kHz}$; open drain
Power dissipation	P_{tot}	75	W	$T_c = 25\text{ °C}$
Operating temperature	T_j	-55 to +150	°C	
Storage temperature	T_{stg}	-55 to +150	°C	

1. $V_{DS, \text{transient}}$ is intended for surge rating during non-repetitive events, $t_{\text{Pulse}} < 1\text{ }\mu\text{s}$.

2. Pulse width = $10\text{ }\mu\text{s}$.

2 Electrical characteristics

at $T_j = 25\text{ °C}$, unless specified otherwise.

Table 4 Static characteristics

Parameters	Symbols	Values			Units	Notes/Test Conditions
		Min.	Typ.	Max.		

Gate threshold voltage	$V_{GS(TH)}$	2.0	2.6	3.5	V	$I_D = 9 \text{ mA}; V_{DS} = V_{GS}; T_J = 25 \text{ }^{\circ}\text{C}$
		-	3	-		$I_D = 9 \text{ mA}; V_{DS} = V_{GS}; T_J = 150 \text{ }^{\circ}\text{C}$
Drain-source leakage current	I_{DSS}	-	0.01	0.9	μA	$V_{DS} = 900 \text{ V}; V_{GS} = 0 \text{ V}; T_J = 25 \text{ }^{\circ}\text{C}$
		-	1	-		$V_{DS} = 900 \text{ V}; V_{GS} = 0 \text{ V}; T_J = 150 \text{ }^{\circ}\text{C}$
Gate-source leakage current	I_{GSS}	-	1	-	mA	$V_{GS} = 6 \text{ V}; V_{DS} = 0 \text{ V}$
Drain-source on-state Resistance ¹	$R_{DS(on)}$	-	180	200	mΩ	$V_{GS} = 6 \text{ V}; I_D = 3 \text{ A}; T_J = 25 \text{ }^{\circ}\text{C}$
		-	432	-	mΩ	$V_{GS} = 6 \text{ V}; I_D = 3 \text{ A}; T_J = 150 \text{ }^{\circ}\text{C}$
Gate resistance	R_G	-	6.5	-	Ω	$f = 5 \text{ MHz}; \text{open drain}$

1. $R_{DS(on)}$ is the test of fresh devices

Table 5 Dynamic characteristics

Parameters	Symbols	Values			Units	Notes/Test Conditions
		Min.	Typ.	Max.		
Input capacitance	C_{iss}	-	65	-	pF	$V_{GS} = 0 \text{ V}; V_{DS} = 400 \text{ V}; f = 100\text{KHZ}$
Output capacitance	C_{oss}	-	20.6	-	pF	$V_{GS} = 0 \text{ V}; V_{DS} = 400 \text{ V}; f = 100\text{KHZ}$
Reverse transfer capacitance	C_{rss}	-	0.14	-	pF	$V_{GS} = 0 \text{ V}; V_{DS} = 400 \text{ V}; f = 100\text{KHZ}$
Effective output capacitance, energy related ¹	$C_{o(er)}$	-	30	-	pF	$V_{GS} = 0 \text{ V}; V_{DS} = 0 \text{ to } 400 \text{ V}$
Effective output capacitance, time related ²	$C_{o(tr)}$	-	48	-	pF	$V_{GS} = 0 \text{ V}; V_{DS} = 0 \text{ to } 400 \text{ V}$
Output charge	Q_{oss}	-	17	-	nC	$V_{GS} = 0 \text{ V}; V_{DS} = 0 \text{ to } 400 \text{ V}$
Turn-on delay time	$t_{d(on)}$	-	2	-	ns	$V_{DS} = 400 \text{ V}; I_D = 6 \text{ A}; L = 318 \mu\text{H};$ $V_{GS} = 6 \text{ V}; R_{on} = 10 \Omega; R_{off} = 2 \Omega$
Turn-off delay time	$t_{d(off)}$	-	3	-	ns	
Rise time	t_r	-	4	-	ns	
Fall time	t_f	-	5	-	ns	

1. $C_{o(er)}$ is the fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 400 V.

2. $C_{o(tr)}$ is the fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 400 V.

Table 6 Gate charge characteristics

Parameters	Symbols	Values			Units	Notes/Test Conditions
		Min.	Typ.	Max.		
Gate charge	Q_G	-	2	-	nC	$V_{GS} = 0 \text{ to } 6 \text{ V}; V_{DS} = 400 \text{ V};$ $I_D = 3 \text{ A}$
Gate-source charge	Q_{GS}	-	0.4	-	nC	

Gate-drain charge	Q_{GD}	-	0.7	-	nC	
Gate plateau voltage	V_{plat}	-	2.5	-	V	$V_{DS} = 400\text{ V}; I_D = 3\text{ A}$

Table 7 Reverse conduction characteristics

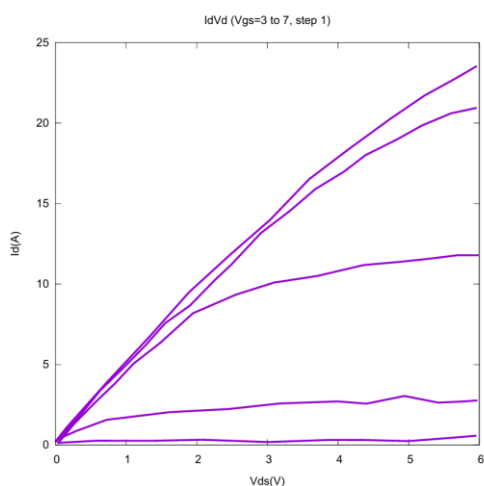
Parameters	Symbols	Values			Units	Notes/Test Conditions
		Min.	Typ.	Max.		
Source-drain reverse voltage	V_{SD}	-	4	-	V	$V_{GS} = 0\text{ V}; I_{SD} = 3\text{ A}$
Pulsed current, reverse	$I_{S, pulse}$	-	-	18	A	$V_{GS} = 6\text{ V}$
Reverse recovery charge ¹	Q_{rr}	-	0	-	nC	$I_{SD} = 3\text{ A}; V_{DS} = 400\text{ V}$
Reverse recovery time	t_{rr}	-	0	-	ns	
Peak reverse recovery current	I_{rrm}	-	0	-	A	

1. Excluding Q_{OSS}

3 Electrical characteristics diagrams

at $T_J = 25\text{ °C}$, unless specified otherwise.

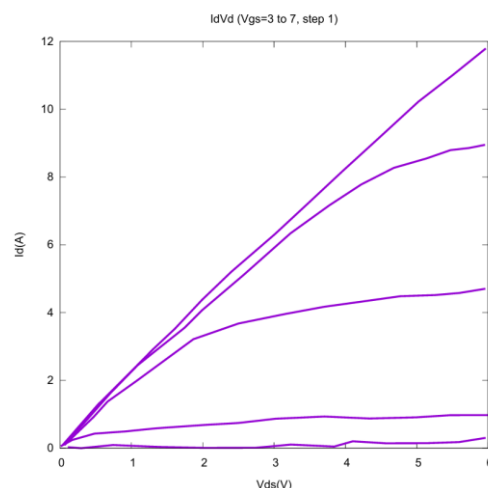
Figure 1 Typ. output characteristics



$$I_D = f(V_{DS}, V_{GS}); T_J = 25\text{ °C}$$

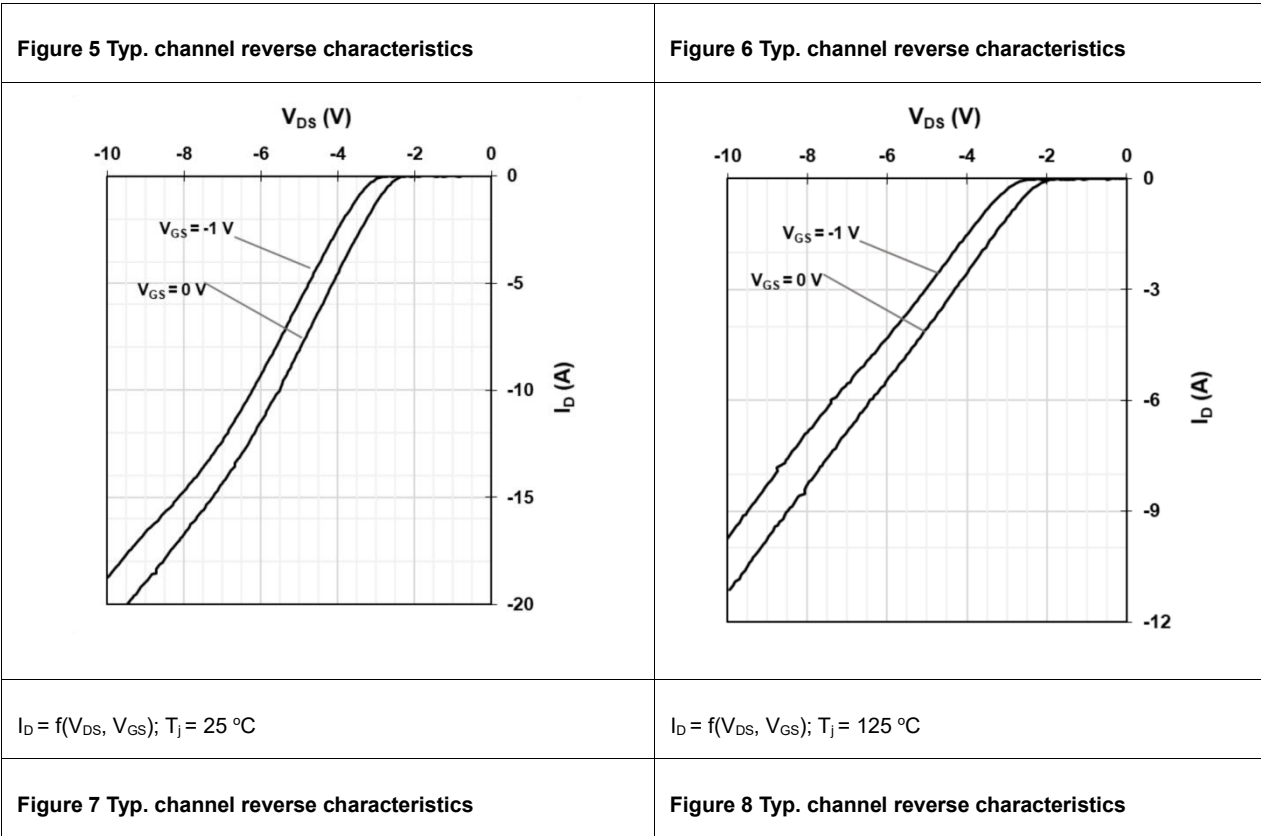
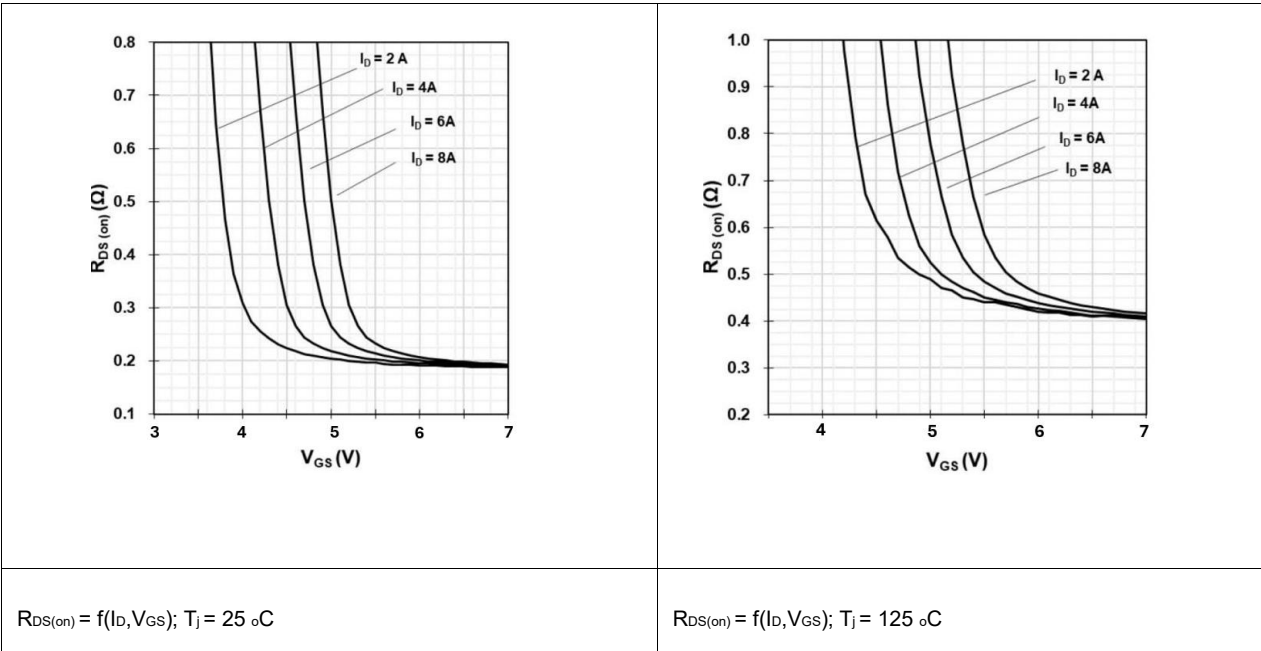
Figure 3 Typ. drain-source on-state resistance

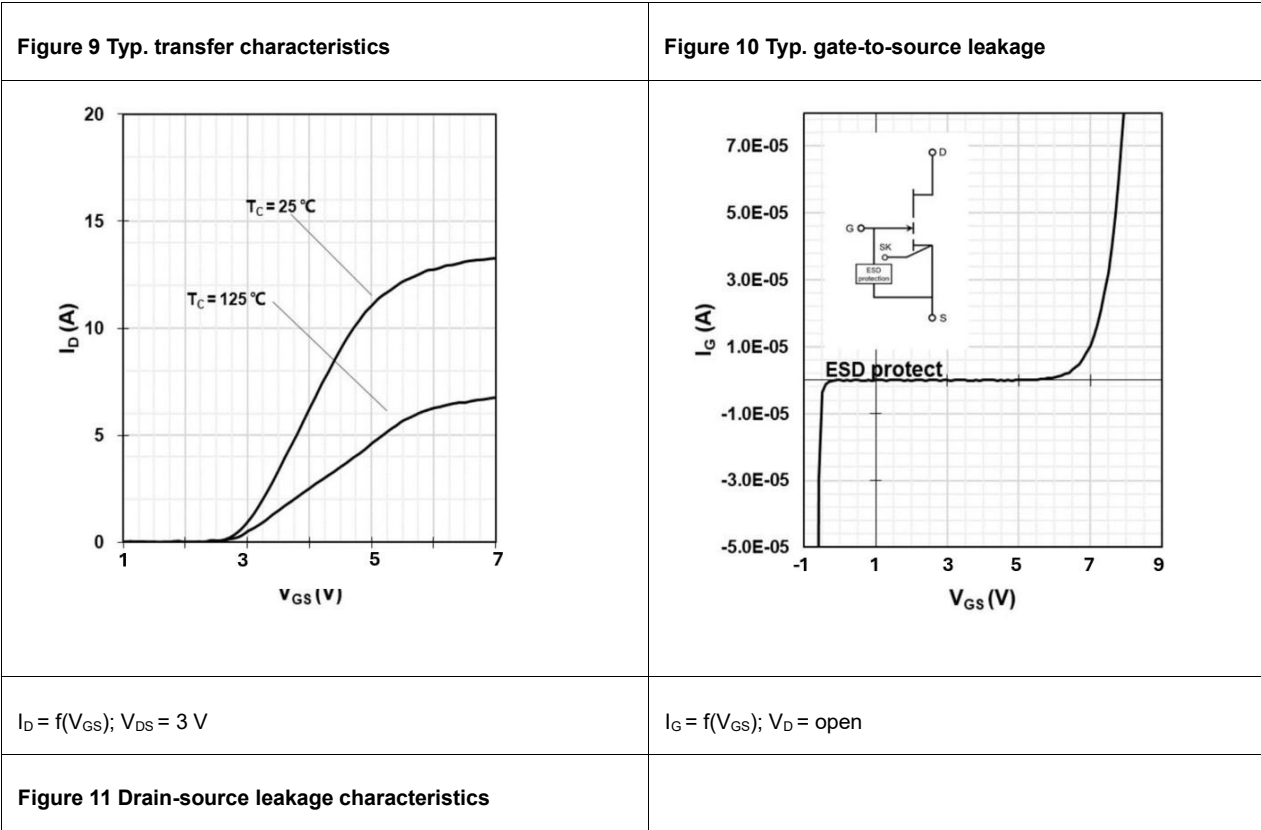
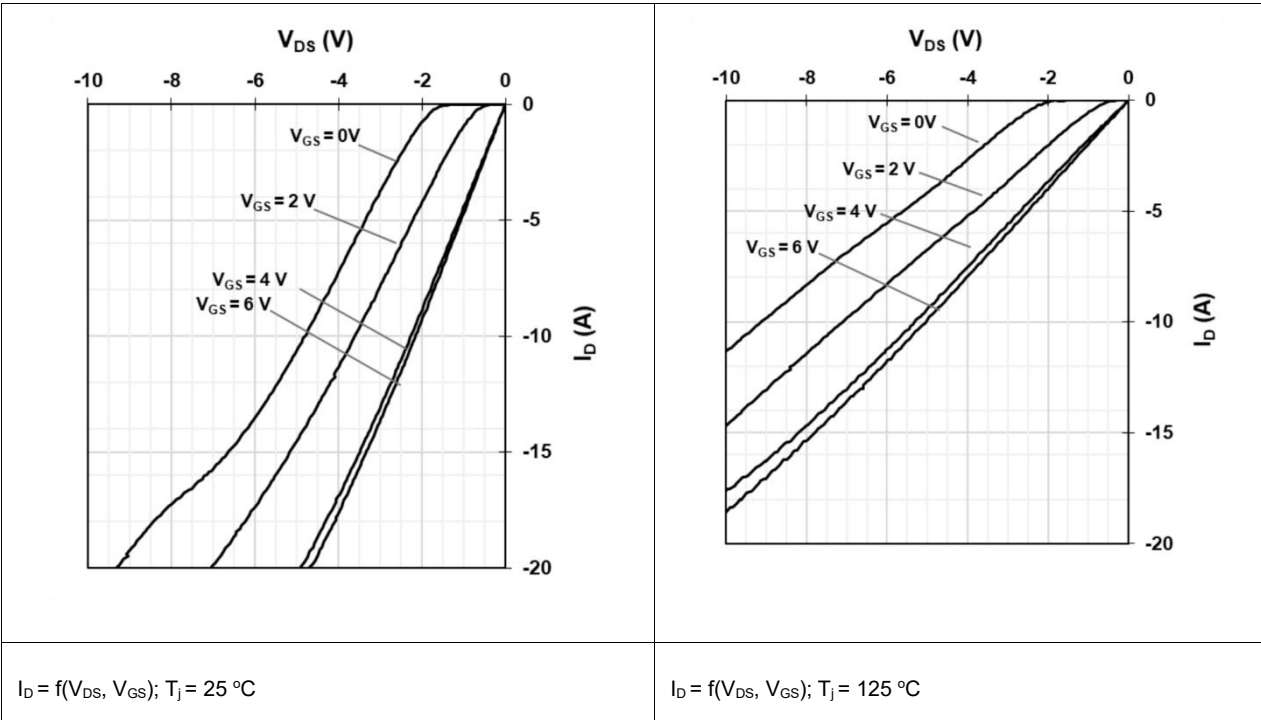
Figure 2 Typ. output characteristics



$$I_D = f(V_{DS}, V_{GS}); T_J = 125\text{ °C}$$

Figure 4 Typ. drain-source on-state resistance





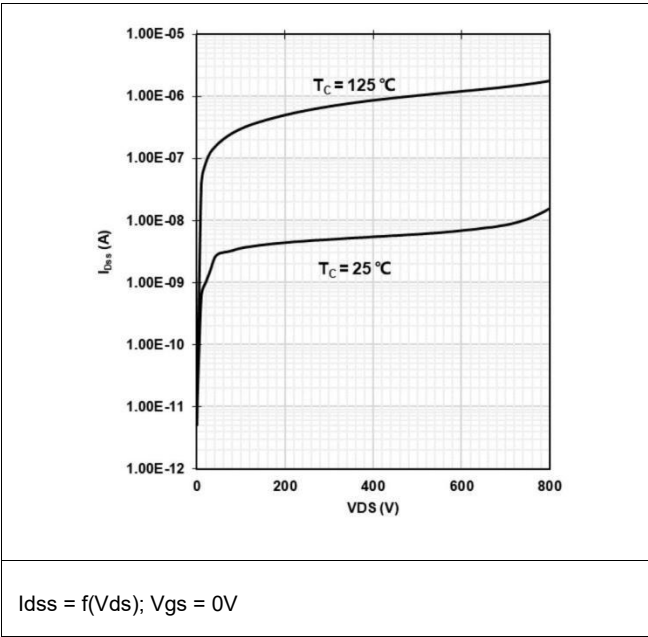


Figure 12 Typ. capacitances

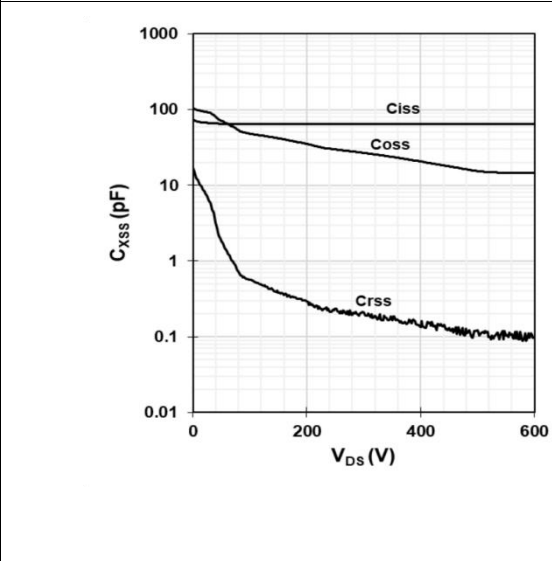
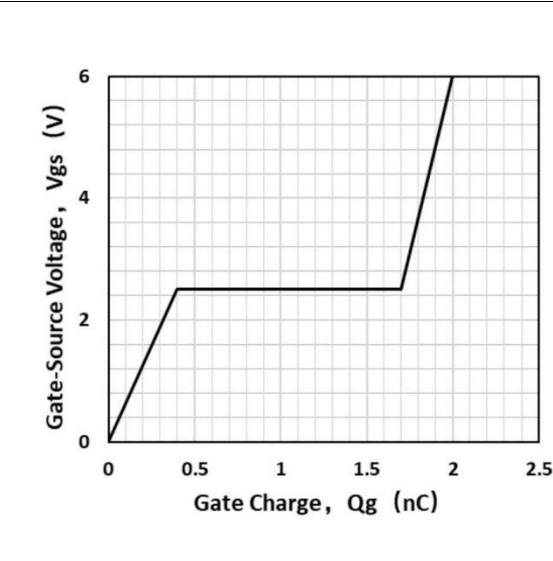


Figure 13 Typ. gate charge

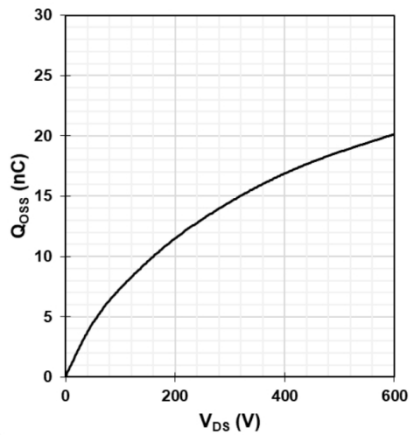


$C_{XSS} = f(V_{DS}); \text{Freq.} = 100\text{kHz}$

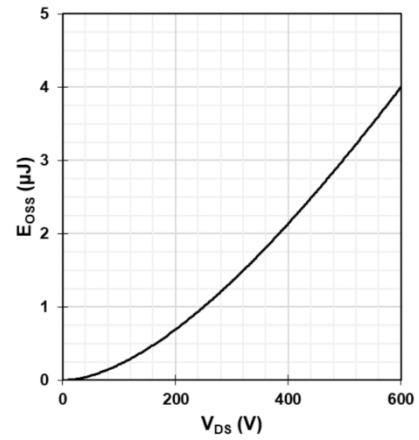
$V_{GS} = f(Q_G); V_{DS} = 400\text{ V}; I_D = 3\text{ A}$

Figure 14 Typ. output charge

Figure 15 Typ. C_{oss} stored energy

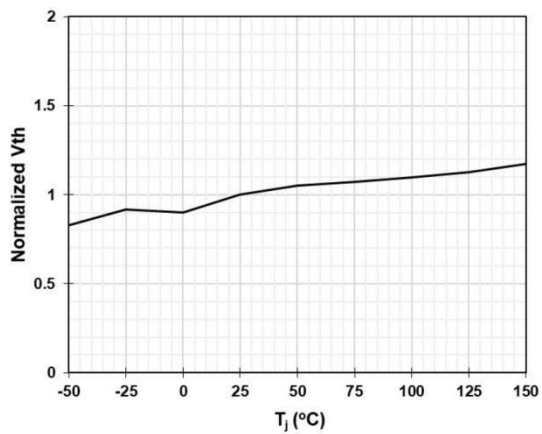


$$Q_{oss} = f(V_{DS}); \text{Freq.} = 100\text{kHz}$$



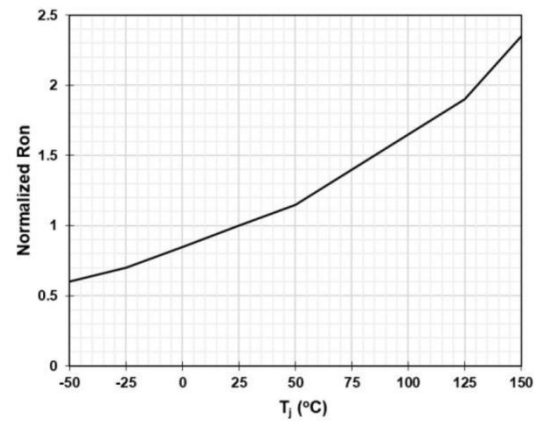
$$E_{oss} = f(V_{DS}); \text{Freq.} = 100\text{kHz}$$

Figure 16 Gate threshold voltage



$$V_{GS(TH)} = f(T_j); V_{GS} = V_{DS}; I_D = 9 \text{ mA}$$

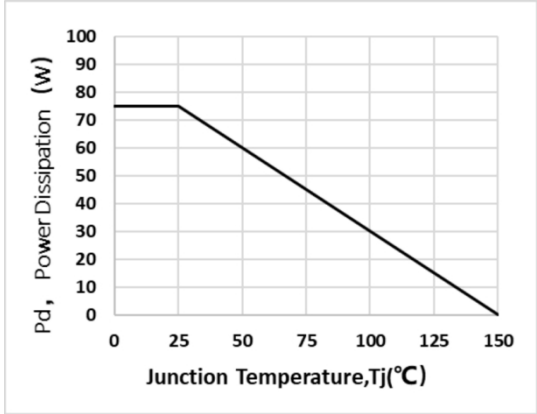
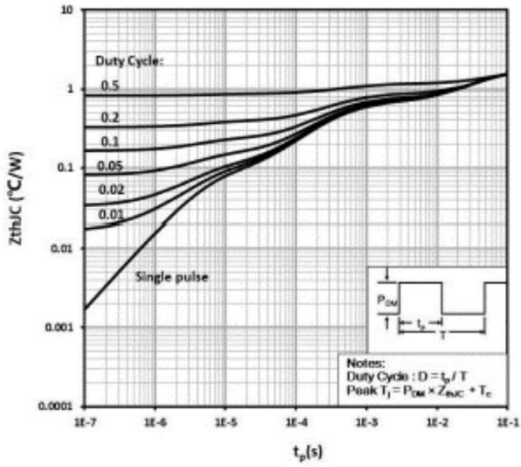
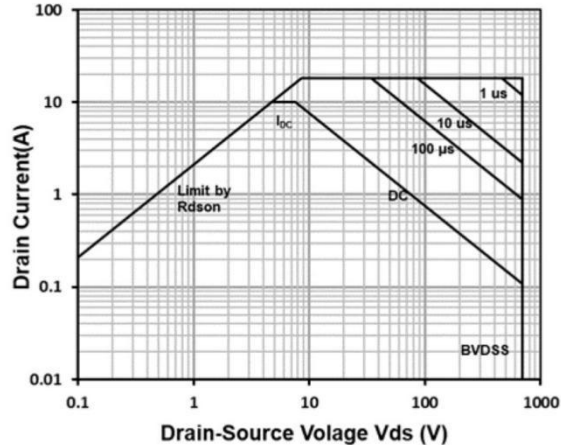
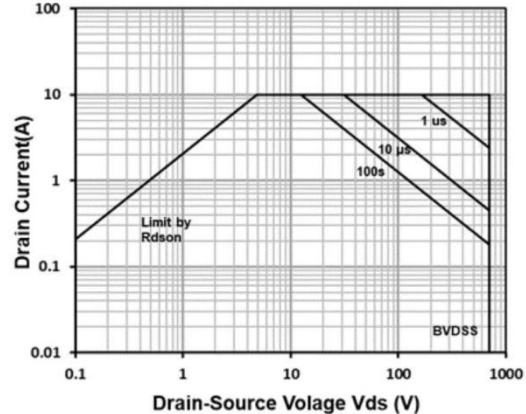
Figure 17 Drain-source on-state resistance

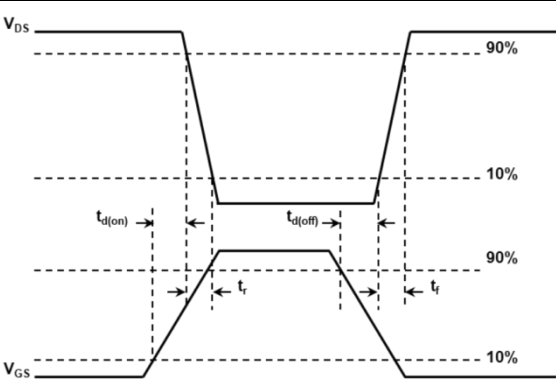
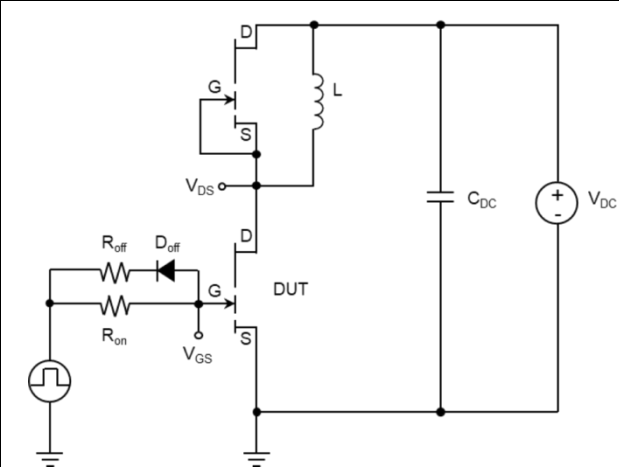


$$R_{DS(on)} = f(T_j); I_D = 3 \text{ A}; V_{GS} = 6 \text{ V}$$

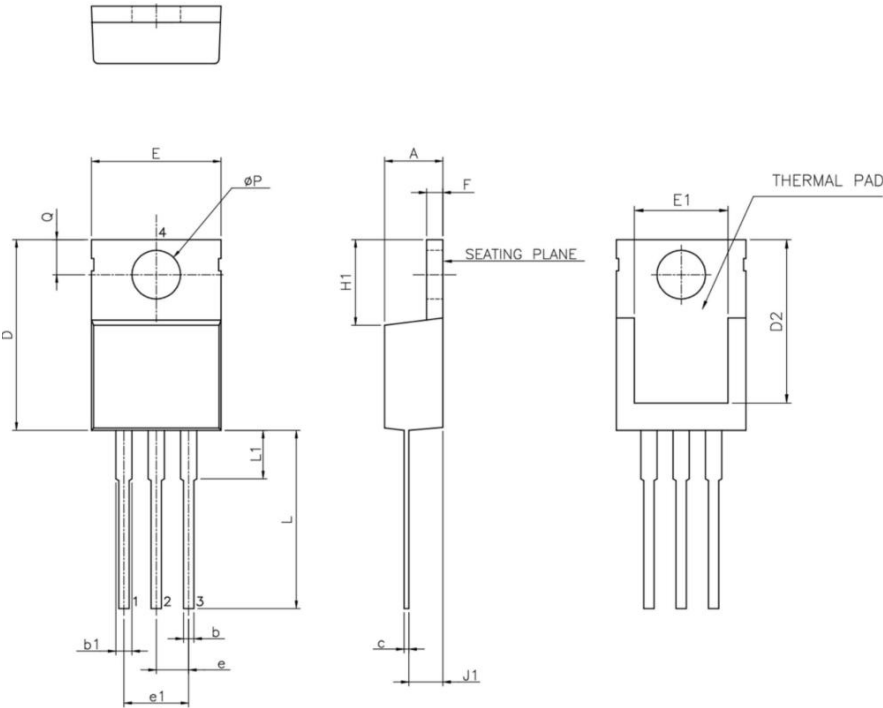
Figure 18 Power dissipation

Figure 19 Max.transient thermal impedance

	
$P_{tot} = f(T_c)$	$Z_{thjc} = f(t_p, D)$
Figure 20 Safe Operation Area 	Figure 21 Safe Operation Area 
$I_d = f(V_{ds}); T_c = 25^{\circ}\text{C}$	$I_d = f(V_{ds}); T_c = 125^{\circ}\text{C}$
Figure 22 Switching time test circuit	Figure 23 Typ. switching time waveforms



$V_{DS} = 400\text{ V}$, $I_D = 6\text{ A}$, $L = 318\text{ }\mu\text{H}$, $V_{GS} = 6\text{ V}$,
 $R_{DS(on)} = 10\text{ }\Omega$, $R_{DS(off)} = 2\text{ }\Omega$



VARIATIONS (ALL DIMENSIONS SHOWN IN MM)

SYMBOLS	MIN.	MAX.
A	3.56	4.82
b1	1.15	1.77
b	0.38	1.01
c	0.35	0.61
D	14.23	16.51
E	9.66	10.66
D2	11.75	11.90
E1	6.86	8.90
e	2.29	2.79
e1	4.83	5.33
F	0.51	1.39
H1	5.85	6.85
J1	2.04	2.92
L	12.70	14.73
øP	3.54	4.08
Q	2.54	3.42
L1	3.65	6.35

NOTES:
1. JEDEC OUTLINE : N/A.

4 Revision history

Major changes since the last revision

Revision	Date	Description of changes
0.1	2025-10-23	0.1 version release

6 Further Information

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Data Source— Data here are based on recent tests but all parameters may not be up to date. Actual final test data from packaging production are available for selected customers upon request.